ASSOCIATION CONNECTI ELECTRONICS INDUSTRI	Material Compos © Copyright 2005. IPC international and Pan-A	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ous Materia	ials and Mfg Information				
upplier Infori	nation															
Company name*			Company unique ID			τ	Unique ID Authority					Response Date*				
nsemi												2023-06-08				
Contact Name			Title - Contact			1	Phone - Contact*					Email - Contact*				
Product-Env-Stew	ards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
uthorized Repres	entative*		Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-Env-Stew	ards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
Reques	Requester Item Number Mfr It		em Number Mfr Item Name				Effective Dat	Date Version Manufacturing Si		ng Site	Weight*		UOM	Unit Type		
		MC74HC 2G	74HCT574ADWR LOG CMOS D FLII		LIP FLOP OC	TL	2023-06-08		PH1			5	17.71	mg	Each	
Ianufacturing	Process Information	on														
Terminal Plating / Grid Array Material To			Ferminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperature Max Time at P		ne at Peak	Temperati	ire Num	ber of Reflow Cy	eles				
Matte Tin (Sn) - annealed		C	CU Alloy 3		3		260 C		C	30 seco		secono	is 3			
omments																
TTENTION: MS	L 3 Rated item requires I	Bake and Di	ry Pack (after	electrical test)								·				
or more informat	ion regarding material co	omposition p	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	9.33	mg	Supplier	Silicon (Si)	7440-21-3		9.33	mg
Die Attach	20.68	mg		Epoxy resin	proprietary data		2.068	mg
			Supplier	Ethylene dimethacrylate	97-90-5		1.034	mg
			Supplier	Silver (Ag)	7440-22-4		16.544	mg
			Supplier	Formaldehyde Polymer	9003-36-5		1.034	mg
Lead Frame	323.98	mg	Supplier	Silver (Ag)	7440-22-4		3.2398	mg
			Supplier	Zinc (Zn)	7440-66-6		0.648	mg
			Supplier	Iron (Fe)	7439-89-6		8.4235	mg
			Supplier	Copper (Cu)	7440-50-8		311.6688	mg
Mold Compound-Black	158.46	mg		Epoxy resin	proprietary data		7.923	mg
			Supplier	Phenolic Resin	Proprietary Data		3.1692	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.9615	mg
			Supplier	Carbon Black (C)	1333-86-4		0.7923	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		142.614	mg
Plating	4.79	mg	Supplier	Tin (Sn)	7440-31-5		4.79	mg
Wire Bond - Cu	0.47	mg	Supplier	Copper (Cu)	7440-50-8		0.47	mg